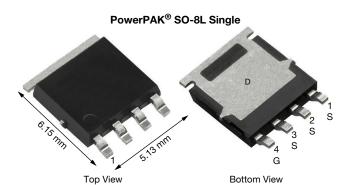
COMPLIANT

HALOGEN

**FREE** 

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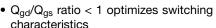
# N-Channel 40 V (D-S) MOSFET



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	40				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.00163				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.00230				
Q <sub>g</sub> typ. (nC)	32				
I <sub>D</sub> (A) <sup>a</sup>	131				
Configuration	Single				

#### **FEATURES**

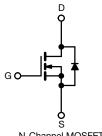
- TrenchFET® Gen IV power MOSFET
- $\bullet$  Tuned for the lowest  $R_{DS}\text{-}Q_{oss}$  FOM
- 100 % Rq and UIS tested





## **APPLICATIONS**

- · Synchronous rectification
- High power density DC/DC
- DC/AC inverters
- · Battery and load switch



N-Channel M	OSFET
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ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SiJA52ADP-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T	$_{A} = 25  ^{\circ}\text{C}$ , unless	s otherwise not	ed)	
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	40	V
Gate-source voltage		$V_{GS}$	+20, -16	V
	T <sub>C</sub> = 25 °C		131	
Continuous dusin summent /T 150 °C\	T <sub>C</sub> = 70 °C	] , [	105	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	41.6 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C	1	33.3 b, c	
Pulsed drain current (t = 100 μs)	I <sub>DM</sub>	200	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C	,	43.6	
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	4.3 b, c	
Single pulse avalanche current		I <sub>AS</sub>	35	
Single pulse avalanche energy  L = 0.1 mH		E <sub>AS</sub>	61	mJ
	T <sub>C</sub> = 25 °C		48	
Maximum power dissipation	T <sub>C</sub> = 70 °C	] _ [	30.7	w
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	4.8 <sup>b, c</sup>	] vv
	T <sub>A</sub> = 70 °C	1	3 b, c	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Soldering recommendations (peak temperature) d, e			260	]

THERMAL RESISTANCE RATING	as .				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b, f	t ≤ 10 s	R <sub>thJA</sub>	22	26	°C/W
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	1.7	2.6	C/VV

#### Notes

- a.  $T_C = 25 \,^{\circ}C$ b. Surface mounted on 1" x 1" FR4 board
- t = 10 s

- Rework conditions: manual soldering with a soldering iron is not recommended for leadless component
- Maximum under steady state conditions is 70 °C/W

See solder profile (<a href="https://www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

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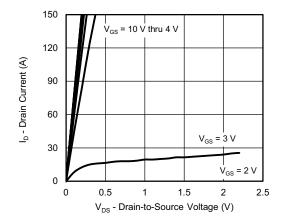
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, $\iota$	inless otherv	vise noted)				
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•		
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$		-	22	-	14/00
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5.8	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.1	-	2.4	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = +20, -16 \text{ V}$	-	-	± 100	nA
7		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10	μΑ
On-state drain current a	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α
Desire and the second of the s	5	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	-	0.00130	0.00163	-
Drain-source on-state resistance a	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	0.00190	0.00230	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 15 A	-	98	-	S
Dynamic <sup>b</sup>			•	•		
Input capacitance	C <sub>iss</sub>		-	5500	-	
Output capacitance	C <sub>oss</sub>		-	1086	-	pF
Reverse transfer capacitance	$C_{rss}$	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	67	-	
C <sub>rss</sub> /C <sub>iss</sub> ratio			-	0.013	-	
		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$	-	66	100	
Total gate charge	Qg		-	32	60	
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	15	-	nC
Gate-drain charge	Q <sub>gd</sub>		-	4.5	-	
Output charge	Q <sub>oss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	-	50	75	
Gate resistance	$R_q$	f = 1 MHz	0.4	1.1	2.0	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	17	34	
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_{L} = 2 \Omega$	-	6	12	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	38	76	
Fall time	t <sub>f</sub>		-	6	12	
Turn-on delay time	t <sub>d(on)</sub>		-	40	80	ns
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_1 = 2 \Omega$	-	67	134	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	36	72	
Fall time	t <sub>f</sub>		-	11	22	
Drain-Source Body Diode Characteristic	· · ·					
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	43.6	_
Pulse diode forward current (t = 100 μs)	I <sub>SM</sub>	<del>-</del>	-	-	200	Α
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A	-	0.71	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>	<del>-</del>	-	50	100	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	56	112	nC
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25  ^{\circ}\text{C}$	-	30	-	
Reverse recovery rise time	t <sub>b</sub>		-	20	-	ns

#### Notes

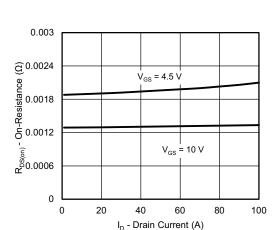
- a. Pulse test; pulse width  $\leq 300~\mu\text{s},$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

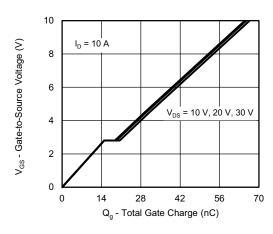




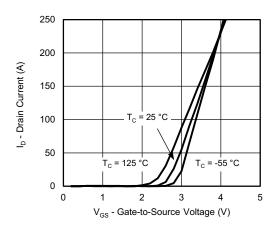
#### **Output Characteristics**



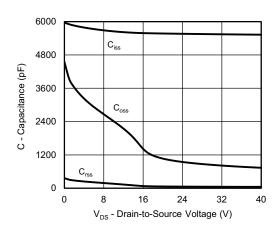
On-Resistance vs. Drain Current



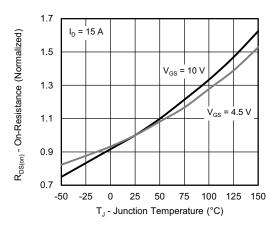
**Gate Charge** 



**Transfer Characteristics** 

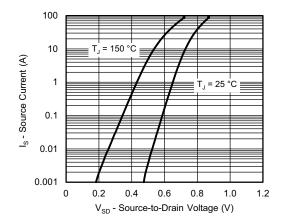


Capacitance

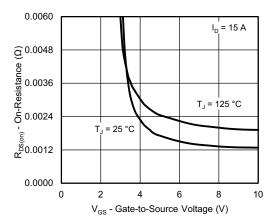


On-Resistance vs. Junction Temperature

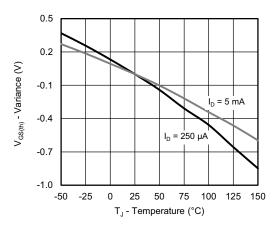




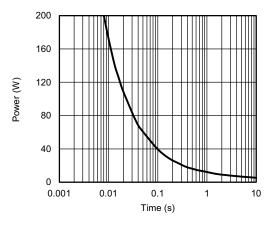
Source-Drain Diode Forward Voltage



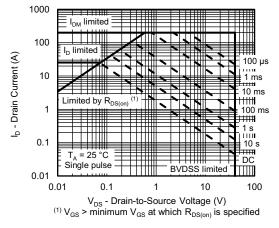
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

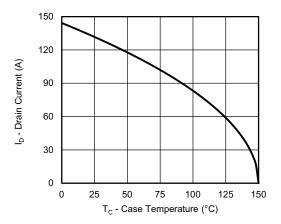


Single Pulse Power, Junction-to-Ambient

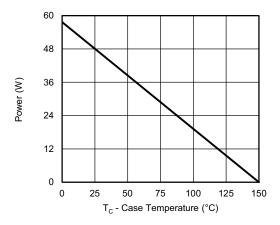


Safe Operating Area

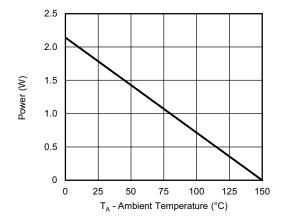




#### Current Derating a



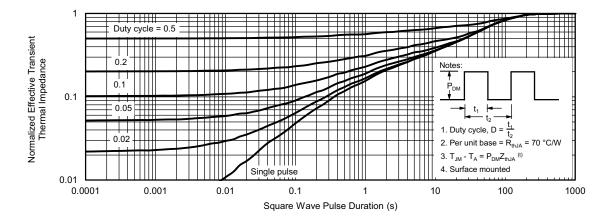




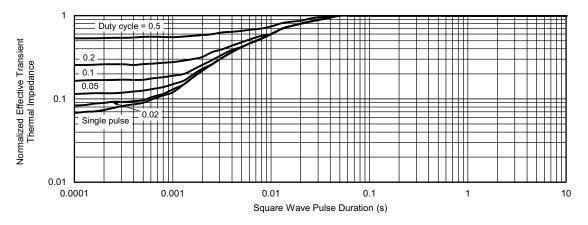
Power, Junction-to-Ambient

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





#### Normalized Thermal Transient Impedance, Junction-to-Ambient

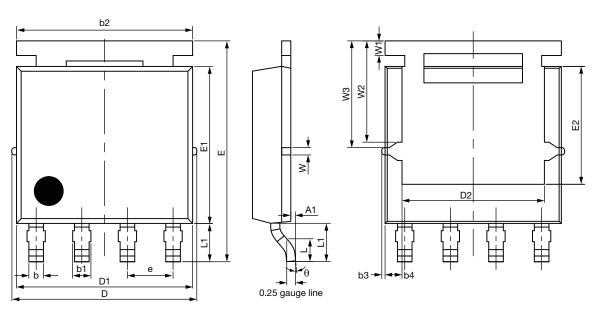


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?76636">www.vishay.com/ppg?76636</a>.

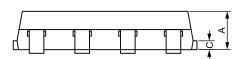


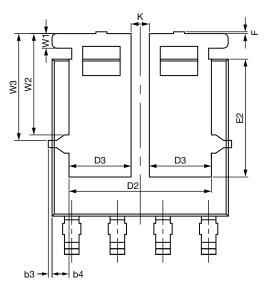
# PowerPAK® SO-8L Case Outline 1



Topside view

Backside view (single)





Backside view (dual)



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DIM		MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
Α	1.00	1.07	1.14	0.039	0.042	0.045		
A1	0.00	-	0.127	0.00	-	0.005		
b	0.33	0.41	0.48	0.013	0.016	0.019		
b1	0.44	0.51	0.58	0.017	0.020	0.023		
b2	4.80	4.90	5.00	0.189	0.193	0.197		
b3		0.094	•		0.004			
b4		0.47			0.019			
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	5.00	5.13	5.25	0.197	0.202	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.86	3.96	4.06	0.152	0.156	0.160		
D3	1.63	1.73	1.83	0.064	0.068	0.072		
е		1.27 BSC	•	0.050 BSC				
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	4.27	4.37	4.47	0.168	0.172	0.176		
E2	3.18	3.28	3.38	0.125	0.129	0.133		
F	-	-	0.15	-	-	0.006		
L	0.62	0.72	0.82	0.024	0.028	0.032		
L1	0.92	1.07	1.22	0.036	0.042	0.048		
K		0.51			0.020			
W		0.23			0.009			
W1	0.41				0.016			
W2	2.82			0.111				
W3		2.96			0.117			
θ	0°	-	10°	0°	-	10°		

ECN: S19-0643-Rev. E, 05-Aug-2019

DWG: 5976

#### Note

• Millimeters will gover



#### RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)



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